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RECORDATION FORM COVER SHEET PATENTS ONLY

<u> </u>	Attorney Docket No.: 053785-5062		
To the Commissioner for Patents			
Please record the attached original documents or copy the	ereof. ATTN: BOX ASSIGNMENT		
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):		
(1) Hyun-Sik SEO	Name: LG.Philips LCD Co., Ltd.		
(2) Binn KIM			
(3) Hae-Yeol KIM	Internal Address:		
Additional names of conveying party(ies) attached? ☐ Yes ⊠ No	Street Address: 20 Yoido-dong, Youngdungpo-gu, Seoul, Korea		
3. Nature of conveyance:	City: State: Zip:		
Security Agreement Change of Name Other	Additional name(s) & address(es) attached?		
Execution Date: (1) 10/10/02 (2) 10/10/02 (3) 10/10/02	☐ Yes No		
4. New Application number(s) or patent number(s):			
A. Patent Application No.(s) 10/310,975 B. Patent No.(s) Additional numbers attached: Yes No			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1		
Name: Robert J. Gaybrick	7. Total fee (37 C.F.R. §3.41):\$40.00 ☐ Enclosed ☐ Authorized to be charged to Deposit Account 50-0310		
Internal Address: Morgan, Lewis & Bockius LLP Customer No. 09629	8. Deposit Account No. 50-0310 (Attach duplicate page if paying by deposit account)		
Street Address: 1111 Pennsylvania Ave., N.W. City: Washington State: D.C. Zip: 20004			
9. Statement and Signature To the best of my knowledge and belief, the foregoing inf	ormation is true and correct and any attached complete true		
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.			
Donald L. Monin, Jr. Reg. No. 47,256 Name of Person Signing Signature	June 12, 2003 Date		
Total n	umber of pages including cover sheet, attachments and documents: 2		
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PATENT REEL: 014166 FRAME: 0251

ATTORNEY DOCKET NO.: 053785-5062

SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I'We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

METHOD OF FABRICATING POLYSILICON THIN FILM TRANSISTOR

WHEREAS, LG.Philips LCD Co., Ltd., a corporation of Korea, whose post office address is 20 Yoido-dong, Youngdungpo-gu, Scoul, Korea, (hereinafter referred to as Assignes), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HERBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. $\frac{10/310.975}{10/310.975}$ filed $\frac{12/6/02}{10/310.975}$) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s). Full Name of Sole or First Assigner Assignor's Sign<u>ature</u> Date 57K Hyun-Sik SEO 10. Oct Hyun_ Address 3-202 Hyoseong-Sanga APT, 308-3, Bisan-dong, Dongan-gu, Anyang-si, Gyeonggi-do, Citizenship Republic of Korea Republic of Kores Full Name of Second Assignor Date Assignor's Signature Binn KIM Binn KIM Address 110-910 Hyundae APT, Sconsa, Amsa-dong, Gangdong-gu, Scoul, Republic of Korca Citizenship Republic of Korea Full Name of Third Assignor Assignor's Signature Date long-Uk BAE Address 808-1208 Mokdong APT, Singleong6-dong, Yangcheon-gu, Seoul, Republic of Korea Citizenship Republic of Korea Assignor's Signature Full Name of Fourth Assignor 10/0C+/2002 Hae-Yeol KIM Address 103-701 Chowon Scongwon APT, Pycongchon-dong, Dongan-gu, Annyang-si, Citizenship Gyeonggi-do, Republic of Korea Republic of Korea Varnes of additional inventors attached ☐Y¢8

Morgan, Lewis & Bockius LLP

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RECORDED: 06/12/2003

PATENT REEL: 014166 FRAME: 0252